

# BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC1945$

# ADJUSTABLE PRECISION SHUNT REGULATORS

## DESCRIPTION

The  $\mu$  PC1945 is an adjustable-shunt regulator featuring a high-precision internal reference voltage. The separate power supply pin (Vcc pin) allows the cathode voltage to be dropped to as low as 0.4V, making this product ideal for error amplifiers that use a low voltage (minimum 1.8 V) output switching regulator.

Support for high-density mounting is also provided through the use of a 5-pin plastic mini-mold package.

#### FEATURES

- Separate cathode and power supply pins
- Suitable for low voltage (minimum 1.8 V) output switching regulator

Cathode voltage range: 0.4 V to 5 V

Power supply voltage range: VREF to 5 V

Reference voltage: 1.26 V

 5-pin plastic mini-mold package Mold dimensions: 2.9 mm(L)×1.5 mm(W)×1.1 mm(H)

# ORDERING INFORMATION

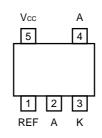
Part Number	Package	Marking	Form of Shipment
$\mu$ PC1945TA	5-pin plastic mini-mold	K95	-
	(SC-74A)		
$\mu$ PC1945TA-E1	5-pin plastic mini-mold	K95	Embossed taping
	(SC-74A)		Pin 1 in wind-in direction
			• 3000 units/reel
$\mu$ PC1945TA-E2	5-pin plastic mini-mold	K95	Embossed taping
	(SC-74A)		Pin 1 in pull-out direction
			• 3000 units/reel

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# PIN CONNECTION (Top View)

5-pin plastic mini-mold (SC-74A)

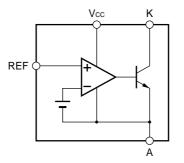
## μPC1945TA



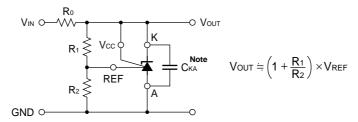
Pin No	Pin Symbol	Pin Name
1	REF	Reference
2	А	Anode
3	к	Cathode
4	А	Anode
5	Vcc	Supply Voltage

Caution It is recommended to connect pins 2 and 4 externally. If this is not possible, leave pin 2 open.

## **BLOCK DIAGRAM**



### STANDARD CONNECTION



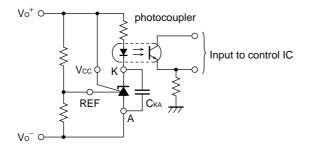
**Note** CKA = 100 pF minimum. Connect to prevent oscillation.

#### Caution Supply K (Cathode) and Vcc from the same power supply.

**Remark** The  $\mu$ PC1945 is represented by the following symbol in this data sheet.



# APPLICATION CIRCUIT EXAMPLE



# ABSOLUTE MAXIMUM RATINGS

(Unless otherwise specified,  $T_A = 25^{\circ}C$ )

Parameter	Symbol	Ratings	Unit
Supply Voltage	Vcc	6	V
Cathode Voltage	Vк	Vcc	V
Cathode Current	lκ	15	mA
Cathode/Anode Reverse Current	—Ік	-5	mA
Reference Current	IREF	50	μA
Reference/Anode Reverse Current	-IREF	-5	mA
Circuit Current	lcc	2	mA
Total Power Dissipation	Рт	90	mW
Operating Ambient Temperature	TA	-20 to+85	°C
Operating Junction Temperature	TJ	-20 to+125	°C

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

#### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	Vref		5	V
Cathode Voltage	Vк	0.4		Vcc <sup>Note</sup>	V
Cathode Current	lκ			12	mA
Total Power Dissipation	Рт			20	mW
Operating Ambient Temperature	TA	-20		+85	°C
Operating Junction Temperature	TJ	-20		+100	°C

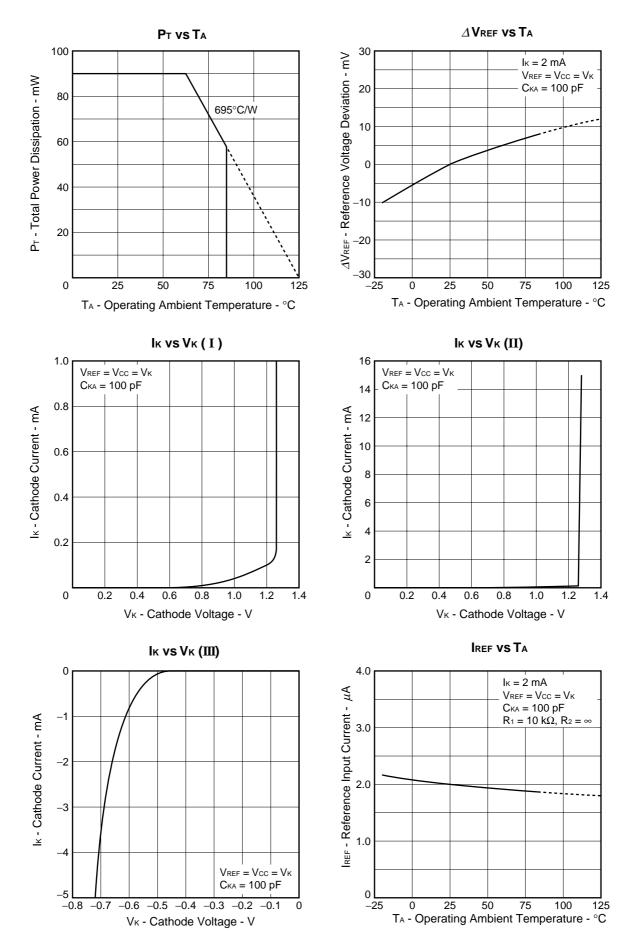
Note  $V_{K} \leq V_{CC}$ 

Caution The recommended operating range may be exceeded without causing any problems provided that the absolute maximum ratings are not exceeded. However, if the device is operated in a way that exceeds the recommended operating conditions, the margin between the actual conditions of use and the absolute maximum ratings is small, and therefore thorough evaluation is necessary. The recommended operating conditions do not imply that the device can be used with all values at their maximum values.

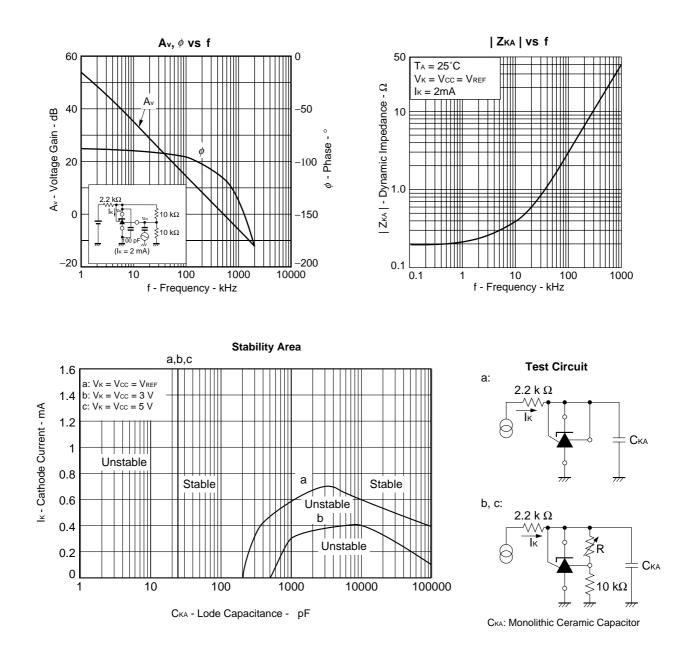
# ELECTRICAL SPECIFICATIONS

(Unless otherwise specified,  $T_A = 25^{\circ}C$ ,  $I_K = 2 \text{ mA}$  ( including Icc ),  $V_{REF} = V_{CC} = V_K$ ,  $C_{KA} = 100 \text{ pF}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Reference Voltage	Vref		1.235	1.26	1.285	V
Reference Voltage Deviation Over Temperature	$ \Delta V$ ref	0°C ≤T≜≤+70°C		5	30	mV
Reference Voltage Deviation Over Supply Voltage	$ \Delta V_{REF} / \Delta V_{CC} $	Vref ≤Vk≤5V			1.5	mV/V
Reference Input Current	Iref	R₁ = 10 kΩ, R₂ = ∞		2	4	μA
Reference Input Current Deviation Over Temperature	$ \Delta$  ref	0°C ≤ T <sub>A</sub> ≤ +70°C		0.3	1.2	μA
Minimum Circuit Current	Ісс мін.	$\Delta V_{REF} = -2\%$		110	400	μA
Minimum Cathode Voltage	VK MIN.	Ικ : Icc = 10 : 1		60	400	mV
Off-state Cathode Current	IK OFF	$Vcc = V\kappa = 6 V$ , $Vref = 0 V$		0.01	1	μA
Dynamic Impedance	Zka	f = 1 kHz, 2 mA ≤ lκ ≤ 12 mA		0.3	0.7	Ω
Unity Gain Bandwidth	funity	$R_1 = R_2 = 10 \ k\Omega$		500		kHz



#### **TYPICAL CHRACTERISTICS** (Unless otherwise specified, TA = 25°C Reference Values)

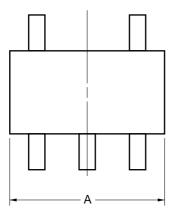


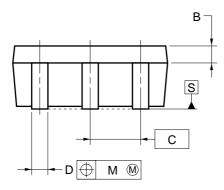
#### **Caution of Stability Area**

When using plural different types of capacitors, each capacitor is needed to be stable independently.

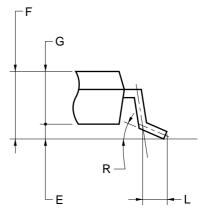
# PACKAGE DRAWING

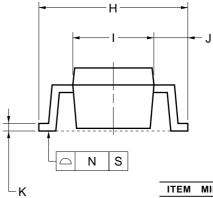
5 PIN PLASTIC MINI MOLD (Unit: mm)





detail of lead end





ITEM	MILLIMETERS
А	2.9±0.2
В	0.3
С	0.95 (T.P.)
D	$0.32\substack{+0.05\\-0.02}$
E	0.05±0.05
F	1.4 MAX.
G	$1.1^{+0.2}_{-0.1}$
Н	2.8±0.2
I	$1.5^{+0.2}_{-0.1}$
J	$0.65^{+0.1}_{-0.15}$
к	$0.16\substack{+0.1\\-0.06}$
L	0.4±0.2
М	0.19
Ν	0.1
R	5°±5°

S5TA-95-15A

## ★ REFERENCE DOCUMENTS

Usage of Three-Terminal-Regulators	G12702E
Review of Quality and Reliability Handbook	C12769E
Semiconductor Device Mounting Technology Manual	C10535E

#### ★ RECOMMENDED SOLDERING CONDITIONS

When soldering this product, it is highly recommended to observe the conditions as shown below. If other soldering processes are used, or if the soldering is performed under different conditions, please make sure to consult with our sales offices.

For more details, refer to our document "SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL" (C10535E).

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 235°C or below (Package surface temperature),	IR35-00-3
	Reflow time: 30 seconds or less (at 210°C or higher),	
	Maximum number of reflow processes: 3 times.	
VPS	Peak temperature: 215°C or below (Package surface temperature),	VP15-00-3
	Reflow time: 40 seconds or less (at 200°C or higher),	
	Maximum number of reflow processes: 3 times.	
Wave soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less,	WS60-00-1
J J	Maximum number of flow processes: 1 time,	
	Pre-heating temperature:120°C or below (Package surface temperature).	

#### μPC1945TA: 5-pin plastic mini-mold (SC-74A)

Caution Apply only one kind of soldering condition to a device, or the device will be damaged by heat stress.

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